

由Autodesk 教育版产品制作

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RoHS

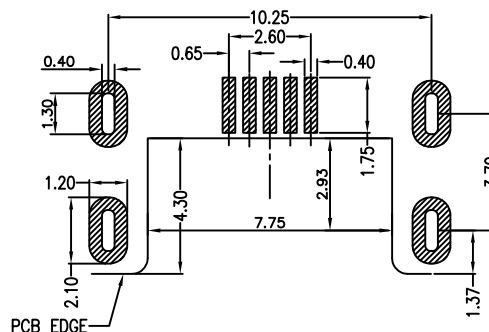
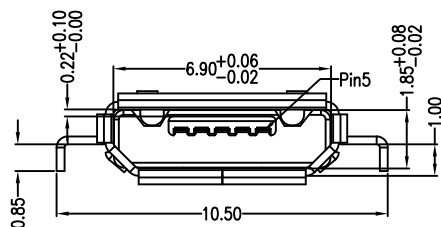
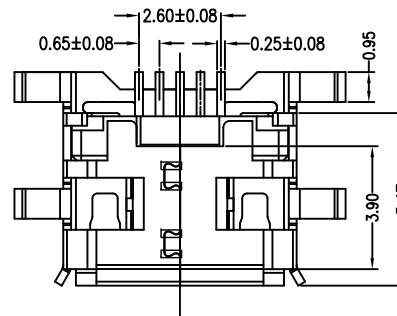
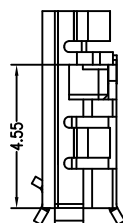
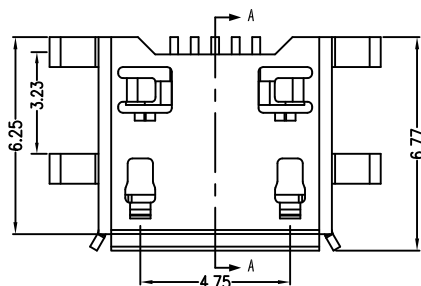
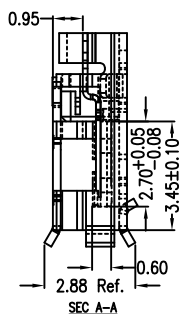
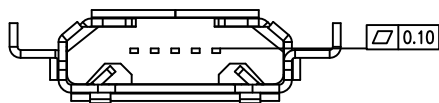
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MAPX

MODIFICATION

DRW

DATE



RECOMMENDED PCB LAYOUT

PCB图仅供参考

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

产品图

PRODUCT CHART DWG

公差一览表

TOLERANCE UNLESS OTHERWISE

X.	±0.25	X.	±5.°
.X	±0.20	.X	±2.°
.XX	±0.15	.XX	±1.°
.XXX	±0.10	.XXX	±0.5°

深圳市精拓金电子有限公司
Shenzhen Jing Tuo Jin Electronics Co., Ltd.

单位 UNITS	MM	制图 DRAWING	XZQ	制图料号 PRODUCT PART NO.	920-F52A2021S10108
比例 SCALE	1:1	审核 CHKD	郭志富	产品名称 PRODUCT NO.	MICRO/5S B型沉板式1.0四脚插板 有边单卡点无孔SMT无接地片
日期 DATE	2016-09-09	核准 APPD	黄国荣	角法 VIEW	版本 VER
					A0